

November 20, 2019

Subject: Sampling LA Package Parts from Carsem-M Assembled Material

To: Our Valued Customer,

Allegro has started initial assembly lots at Carsem-M for our low profile SOICW16 package (suffix LA). As noted in previous communication Unisem-Batam, the current supplier to Allegro Microsystems for the LA package, will be closing their operations on March 31, 2020.

This message is to notify our customers that will need samples from Carsem-M to let us know so as soon as possible. Allegro anticipates having product available from Carsem-M in January 2020 to support Allegro's qualification of Carsem and these sample requests. The target for completion of our commercial qualification is the end of February and automotive qualification is the end of March. We need to start production immediately after this qualification as Unisem does not have the capacity to support an extended bank build prior to closing.



We appreciate your patience and willingness to work with us on this expedited timeframe as we strive to provide you with the quality parts you expect for your application(s).

Please address any questions or concerns to your local sales contact. Thank you for choosing Allegro.

Joshua Bailey



Director, Magnetic Sensors Tactical Marketing

